

Table of Contents

Materials: Metals and Alloys; Ag and Au Thin Films: Electrotransport - Cu: Surface Self-Diffusion	1
Cu: As, Ge and Zn Volume, Grain Boundary and Dislocation Pipe Diffusion - Cu-Ni: Ion Bombardment	39
Cu-Nb and Cu-Fe: Interdiffusion - Ni: Dislocations	53
Ni Films: Twins - Zr-Mo: Stacking Faults	99
Halides and other Ionic Substances	132
Oxides	162
Semiconductors	196
Carbon and Carbides	258
Hydrides, Nitrides, Silicides, Sulfides, Miscellaneous Materials and Liquids	264
General References: Boundaries, Color Centers, Defect Centers, Defect Structures and Diffusion Processes	288
Dislocations, Electrical Conduction, Electrotransport, Electron Irradiation, Ion Bombardment, Ion Implantation and Irradiation Effects	305
Laser Irradiation, Liquid State Properties, Neutron Irradiation, Point Defects, Surfaces, Interfaces, Thermomigration and Voids	317
Book Reviews	328